

# ADC124S051

## 4 Channel, 500 kSPS, 12-Bit A/D Converter

### General Description

The ADC124S051 is a low-power, four-channel CMOS 12-bit analog-to-digital converter with a high-speed serial interface. Unlike the conventional practice of specifying performance at a single sample rate only, the ADC124S051 is fully specified over a sample rate range of 200 kSPS to 500 kSPS. The converter is based on a successive-approximation register architecture with an internal track-and-hold circuit. It can be configured to accept up to four input signals at inputs IN1 through IN4.

The output serial data is straight binary, and is compatible with several standards, such as SPI™, QSPI™, MICROWIRE and many common DSP serial interfaces.

The ADC124S051 operates with a single supply that can range from +2.7V to +5.25V. Normal power consumption using a +3V or +5V supply is 3.0 mW and 10.0 mW, respectively. The power-down feature reduces the power consumption to just 0.14 μW using a +3V supply, or 0.32 μW using a +5V supply.

The ADC124S051 is packaged in a 10-lead MSOP package. Operation over the industrial temperature range of -40°C to +85°C is guaranteed.

### Features

- Specified over a range of sample rates.
- Four input channels
- Variable power management
- Single power supply with 2.7V - 5.25V range

### Key Specifications

- DNL +0.7 / -0.4 LSB (typ)
- INL ± 0.5 LSB (typ)
- SNR 72.5 dB (typ)
- Power Consumption
  - 3V Supply 3.0 mW (typ)
  - 5V Supply 10.0 mW (typ)

### Applications

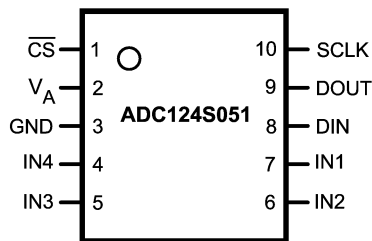
- Portable Systems
- Remote Data Acquisitions
- Instrumentation and Control Systems

### Pin-Compatible Alternatives by Resolution and Speed

All devices are fully pin and function compatible.

Resolution	Specified for a Sample Rate Range of:		
	50 to 200 kSPS	200 to 500 kSPS	500 kSPS to 1 MSPS
12-bit	ADC124S021	<b>ADC124S051</b>	ADC122S101
10-bit	ADC104S021	ADC104S051	ADC102S101
8-bit	ADC084S021	ADC084S051	ADC082S101

### Connection Diagram

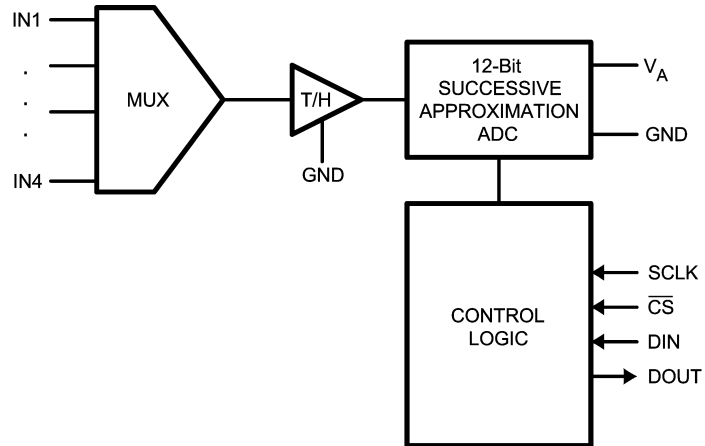


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## Ordering Information

Order Code	Temperature Range	Description	Top Mark
ADC124S051CIMM	-40°C to +85°C	10-Lead MSOP Package	X12C
ADC124S051CIMMX	-40°C to +85°C	10-Lead MSOP Package, Tape & Reel	X12C
ADC124S051EVAL		Evaluation Board	

## Block Diagram



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## Pin Descriptions and Equivalent Circuits

Pin No.	Symbol	Description
<b>ANALOG I/O</b>		
4-7	IN1 to IN4	Analog inputs. These signals can range from 0V to $V_A$ .
<b>DIGITAL I/O</b>		
10	SCLK	Digital clock input. This clock directly controls the conversion and readout processes.
9	DOUT	Digital data output. The output samples are clocked out of this pin on falling edges of the SCLK pin.
8	DIN	Digital data input. The ADC124S051's Control Register is loaded through this pin on rising edges of the SCLK pin.
1	$\overline{CS}$	Chip select. On the falling edge of $\overline{CS}$ , a conversion process begins. Conversions continue as long as $\overline{CS}$ is held low.
<b>POWER SUPPLY</b>		
2	$V_A$	Positive supply pin. This pin should be connected to a quiet +2.7V to +5.25V source and bypassed to GND with a 1 $\mu$ F tantalum capacitor and a 0.1 $\mu$ F ceramic monolithic capacitor located within 1 cm of the power pin.
3	GND	The ground return for the analog supply and signals.

**Absolute Maximum Ratings** (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage $V_A$	-0.3V to 6.5V
Voltage on Any Pin to GND	-0.3V to $V_A$ +0.3V
Input Current at Any Pin (Note 3)	±10 mA
Package Input Current (Note 3)	±20 mA
Power Consumption at $T_A = 25^\circ\text{C}$	See (Note 4)
ESD Susceptibility (Note 5)	
Human Body Model	2500V
Machine Model	250V
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C

**Operating Ratings** (Notes 1, 2)

Operating Temperature Range	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$
$V_A$ Supply Voltage	+2.7V to +5.25V
Digital Input Pins Voltage Range	-0.3V to $V_A$
Clock Frequency	0.8 MHz to 8 MHz
Analog Input Voltage	0V to $V_A$

**Package Thermal Resistance**

Package	$\theta_{JA}$
10-lead MSOP	190°C / W

Soldering process must comply with National Semiconductor's Reflow Temperature Profile specifications. Refer to [www.national.com/packaging](http://www.national.com/packaging). (Note 6)

**ADC124S051 Converter Electrical Characteristics** (Note 9)

The following specifications apply for  $V_A = +2.7\text{V}$  to 5.25V, GND = 0V,  $f_{\text{SCLK}} = 3.2\text{ MHz}$  to 8 MHz,  $f_{\text{SAMPLE}} = 200$  to 500 kSPS,  $C_L = 35\text{ pF}$ , unless otherwise noted. **Boldface limits apply for  $T_A = T_{\text{MIN}}$  to  $T_{\text{MAX}}$** : all other limits  $T_A = 25^\circ\text{C}$ .

Symbol	Parameter	Conditions	Typical	Limits (Note 7)	Units
<b>STATIC CONVERTER CHARACTERISTICS</b>					
	Resolution with No Missing Codes			<b>12</b>	Bits
INL	Integral Non-Linearity		±0.5	<b>±1.1</b>	LSB (max)
DNL	Differential Non-Linearity		+0.7	<b>+1.3</b>	LSB (max)
			-0.4	<b>-1.0</b>	LSB (min)
$V_{\text{OFF}}$	Offset Error		+0.3	<b>±1.3</b>	LSB (max)
OEM	Channel to Channel Offset Error Match		±0.1	<b>±1.0</b>	LSB (max)
FSE	Full Scale Error		-0.5	<b>±1.5</b>	LSB (max)
FSEM	Channel to Channel Full-Scale Error Match		+0.1	<b>±1.0</b>	LSB (max)
<b>DYNAMIC CONVERTER CHARACTERISTICS</b>					
SINAD	Signal-to-Noise Plus Distortion Ratio	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 40.2\text{ kHz}$ , -0.02 dBFS	72	<b>69.2</b>	dB (min)
SNR	Signal-to-Noise Ratio	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 40.2\text{ kHz}$ , -0.02 dBFS	72.5	<b>70.6</b>	dB (min)
THD	Total Harmonic Distortion	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 40.2\text{ kHz}$ , -0.02 dBFS	-84	<b>-75</b>	dB (max)
SFDR	Spurious-Free Dynamic Range	$V_A = +2.7$ to 5.25V $f_{\text{IN}} = 40.2\text{ kHz}$ , -0.02 dBFS	86	<b>76</b>	dB (min)
ENOB	Effective Number of Bits	$V_A = +2.7$ to 5.25V	11.7	<b>11.2</b>	Bits (min)
	Channel-to-Channel Crosstalk	$V_A = +5.25\text{V}$ $f_{\text{IN}} = 40.2\text{ kHz}$	-86		dB
IMD	Intermodulation Distortion, Second Order Terms	$V_A = +5.25\text{V}$ $f_a = 40.161\text{ kHz}$ , $f_b = 41.015\text{ kHz}$	-87		dB
	Intermodulation Distortion, Third Order Terms	$V_A = +5.25\text{V}$ $f_a = 40.161\text{ kHz}$ , $f_b = 41.015\text{ kHz}$	-88		dB
FPBW	-3 dB Full Power Bandwidth	$V_A = +5\text{V}$	11		MHz
		$V_A = +3\text{V}$	8		MHz

**ADC124S051 Converter Electrical Characteristics** (Note 9) (Continued)

The following specifications apply for  $V_A = +2.7V$  to  $5.25V$ ,  $GND = 0V$ ,  $f_{SCLK} = 3.2$  MHz to  $8$  MHz,  $f_{SAMPLE} = 200$  to  $500$  kSPS,  $C_L = 35$  pF, unless otherwise noted. **Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = 25^\circ C$ .

Symbol	Parameter	Conditions	Typical	Limits (Note 7)	Units
<b>ANALOG INPUT CHARACTERISTICS</b>					
$V_{IN}$	Input Range		0 to $V_A$		V
$I_{DCL}$	DC Leakage Current		$\pm 0.02$	<b><math>\pm 1</math></b>	$\mu A$ (max)
$C_{INA}$	Input Capacitance	Track Mode	33		pF
		Hold Mode	3		pF
<b>DIGITAL INPUT CHARACTERISTICS</b>					
$V_{IH}$	Input High Voltage	$V_A = +5.25V$		<b>2.4</b>	V (min)
		$V_A = +3.6V$		<b>2.1</b>	V (min)
$V_{IL}$	Input Low Voltage			<b>0.8</b>	V (max)
$I_{IN}$	Input Current	$V_{IN} = 0V$ or $V_A$	$\pm 0.02$	<b><math>\pm 10</math></b>	$\mu A$ (max)
$C_{IND}$	Digital Input Capacitance		2	<b>4</b>	pF (max)
<b>DIGITAL OUTPUT CHARACTERISTICS</b>					
$V_{OH}$	Output High Voltage	$I_{SOURCE} = 200 \mu A$	$V_A - 0.03$	<b><math>V_A - 0.5</math></b>	V (min)
		$I_{SOURCE} = 1$ mA	$V_A - 0.10$		V
$V_{OL}$	Output Low Voltage	$I_{SINK} = 200 \mu A$	0.02	<b>0.4</b>	V (max)
		$I_{SINK} = 1$ mA	0.1		V
$I_{OZH}, I_{OZL}$	TRI-STATE® Leakage Current		0.005	<b><math>\pm 1</math></b>	$\mu A$ (max)
$C_{OUT}$	TRI-STATE® Output Capacitance		2	<b>4</b>	pF (max)
	Output Coding		Straight (Natural) Binary		
<b>POWER SUPPLY CHARACTERISTICS (<math>C_L = 10</math> pF)</b>					
$V_A$	Supply Voltage			<b>2.7</b>	V (min)
				<b>5.25</b>	V (max)
$I_A$	Supply Current, Normal Mode (Operational, $\overline{CS}$ low)	$V_A = +5.25V$ , $f_{SAMPLE} = 500$ kSPS, $f_{IN} = 40$ kHz	1.9	<b>2.4</b>	mA (max)
		$V_A = +3.6V$ , $f_{SAMPLE} = 500$ kSPS, $f_{IN} = 40$ kHz	0.84	<b>1.2</b>	mA (max)
	Supply Current, Shutdown ( $\overline{CS}$ high)	$V_A = +5.25V$ , $f_{SAMPLE} = 0$ kSPS	60		nA
		$V_A = +3.6V$ , $f_{SAMPLE} = 0$ kSPS	38		nA
$P_D$	Power Consumption, Normal Mode (Operational, $\overline{CS}$ low)	$V_A = +5.25V$	10	<b>12.6</b>	mW (max)
		$V_A = +3.6V$	3.0	<b>4.3</b>	mW (max)
	Power Consumption, Shutdown ( $\overline{CS}$ high)	$V_A = +5.25V$	0.32		$\mu W$
		$V_A = +3.6V$	0.14		$\mu W$
<b>AC ELECTRICAL CHARACTERISTICS</b>					
$f_{SCLK}$	Maximum Clock Frequency	(Note 8)		<b>3.2</b>	MHz (min)
				<b>8</b>	MHz (max)
$f_S$	Sample Rate	(Note 8)		<b>200</b>	kSPS (min)
				<b>500</b>	kSPS (max)
$t_{CONV}$	Conversion Time			<b>13</b>	SCLK cycles
DC	SCLK Duty Cycle	$f_{SCLK} = 8$ MHz	50	<b>30</b>	% (min)
				<b>70</b>	% (max)
$t_{ACQ}$	Track/Hold Acquisition Time	Full-Scale Step Input		<b>3</b>	SCLK cycles
	Throughput Time	Acquisition Time + Conversion Time		<b>16</b>	SCLK cycles

## ADC124S051 Timing Specifications

The following specifications apply for  $V_A = +2.7V$  to  $5.25V$ ,  $GND = 0V$ ,  $f_{SCLK} = 3.2$  MHz to  $8$  MHz,  $f_{SAMPLE} = 200$  to  $500$  kSPS,  $C_L = 35$  pF, **Boldface limits apply for  $T_A = T_{MIN}$  to  $T_{MAX}$** ; all other limits  $T_A = 25^\circ C$ .

Symbol	Parameter	Conditions		Typical	Limits (Note 7)	Units
$t_{CSU}$	Setup Time SCLK High to $\overline{CS}$ Falling Edge	(Note 10)	$V_A = +3.0V$	-3.5	<b>10</b>	ns (min)
			$V_A = +5.0V$	-0.5		
$t_{CLH}$	Hold time SCLK Low to $\overline{CS}$ Falling Edge	(Note 10)	$V_A = +3.0V$	+4.5	<b>10</b>	ns (min)
			$V_A = +5.0V$	+1.5		
$t_{EN}$	Delay from $\overline{CS}$ Until DOUT active		$V_A = +3.0V$	+4	<b>30</b>	ns (max)
			$V_A = +5.0V$	+2		
$t_{ACC}$	Data Access Time after SCLK Falling Edge		$V_A = +3.0V$	+14.5	<b>30</b>	ns (max)
			$V_A = +5.0V$	+13		
$t_{SU}$	Data Setup Time Prior to SCLK Rising Edge			+3	<b>10</b>	ns (min)
$t_H$	Data Valid SCLK Hold Time			+3	<b>10</b>	ns (min)
$t_{CH}$	SCLK High Pulse Width			$0.5 \times t_{SCLK}$	<b>0.3 x <math>t_{SCLK}</math></b>	ns (min)
$t_{CL}$	SCLK Low Pulse Width			$0.5 \times t_{SCLK}$	<b>0.3 x <math>t_{SCLK}</math></b>	ns (min)
$t_{DIS}$	$\overline{CS}$ Rising Edge to DOUT High-Impedance	Output Falling	$V_A = +3.0V$	1.8	<b>20</b>	ns (max)
			$V_A = +5.0V$	1.3		
		Output Rising	$V_A = +3.0V$	1.0		
			$V_A = +5.0V$	1.0		

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

**Note 2:** All voltages are measured with respect to  $GND = 0V$ , unless otherwise specified.

**Note 3:** When the input voltage at any pin exceeds the power supply (that is,  $V_{IN} < GND$  or  $V_{IN} > V_A$ ), the current at that pin should be limited to 10 mA. The 20 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 10 mA to two. The Absolute Maximum Rating specification does not apply to the  $V_A$  pin. The current into the  $V_A$  pin is limited by the Analog Supply Voltage specification.

**Note 4:** The absolute maximum junction temperature ( $T_{Jmax}$ ) for this device is  $150^\circ C$ . The maximum allowable power dissipation is dictated by  $T_{Jmax}$ , the junction-to-ambient thermal resistance ( $\theta_{JA}$ ), and the ambient temperature ( $T_A$ ), and can be calculated using the formula  $P_{DMAX} = (T_{Jmax} - T_A)/\theta_{JA}$ . The values for maximum power dissipation listed above will be reached only when the device is operated in a severe fault condition (e.g. when input or output pins are driven beyond the power supply voltages, or the power supply polarity is reversed). Obviously, such conditions should always be avoided.

**Note 5:** Human body model is 100 pF capacitor discharged through a 1.5 k $\Omega$  resistor. Machine model is 220 pF discharged through zero ohms.

**Note 6:** Reflow temperature profiles are different for lead-free and non-lead-free packages.

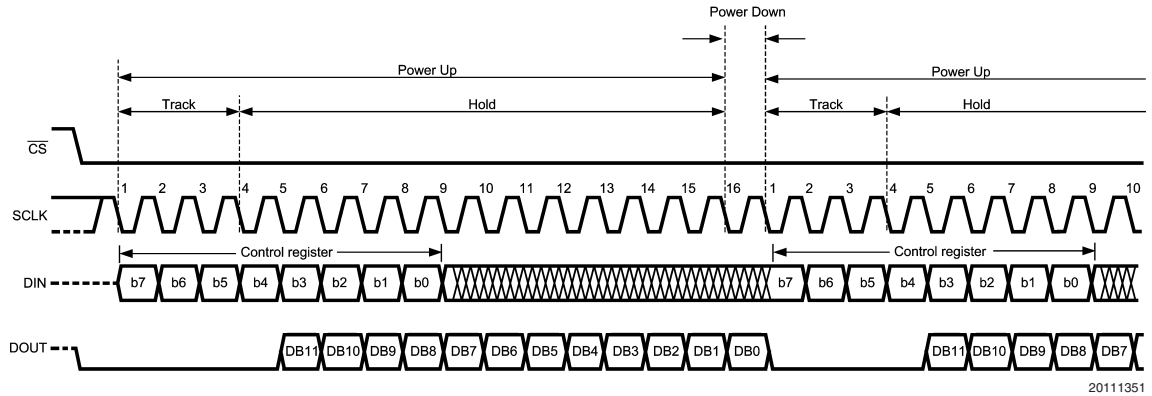
**Note 7:** Tested limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

**Note 8:** This is the frequency range over which the electrical performance is guaranteed. The device is functional over a wider range which is specified under Operating Ratings.

**Note 9:** Data sheet min/max specification limits are guaranteed by design, test, or statistical analysis.

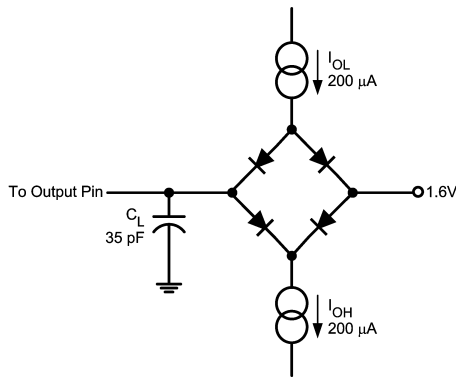
**Note 10:** Clock may be in any state (high or low) when  $\overline{CS}$  is asserted, with the restrictions on setup and hold time given by  $t_{CSU}$  and  $t_{CLH}$ .

# Timing Diagrams



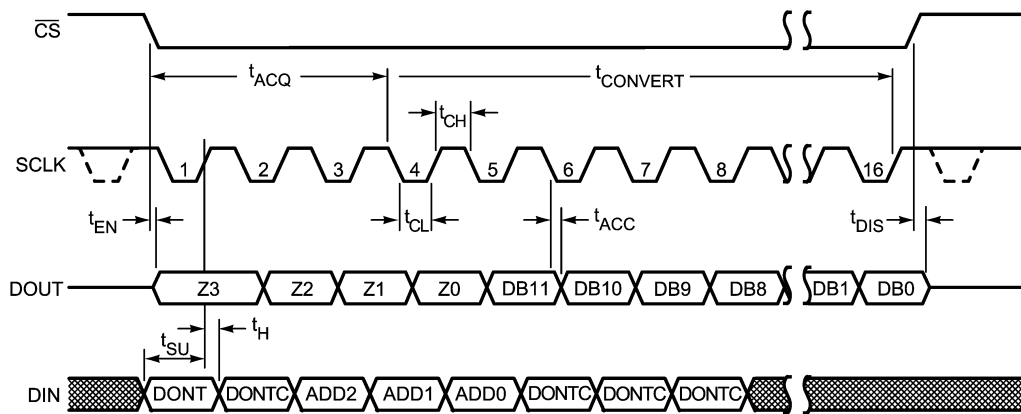
ADC124S051 Operational Timing Diagram

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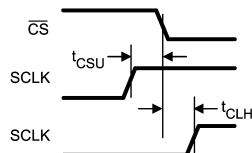
Timing Test Circuit

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ADC124S051 Serial Timing Diagram

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SCLK and  $\overline{CS}$  Timing Parameters

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## Specification Definitions

**ACQUISITION TIME** is the time required to acquire the input voltage. That is, it is time required for the hold capacitor to charge up to the input voltage.

**APERTURE DELAY** is the time between the fourth falling SCLK edge of a conversion and the time when the input signal is acquired or held for conversion.

**CONVERSION TIME** is the time required, after the input voltage is acquired, for the ADC to convert the input voltage to a digital word.

**CROSSTALK** is the coupling of energy from one channel into the other channel, or the amount of signal energy from one analog input that appears at the measured analog input.

**DIFFERENTIAL NON-LINEARITY (DNL)** is the measure of the maximum deviation from the ideal step size of 1 LSB.

**DUTY CYCLE** is the ratio of the time that a repetitive digital waveform is high to the total time of one period. The specification here refers to the SCLK.

**EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS)** is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as  $(\text{SINAD} - 1.76) / 6.02$  and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.

**FULL POWER BANDWIDTH** is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.

**GAIN ERROR** is the deviation of the last code transition (111...110) to (111...111) from the ideal ( $V_{\text{REF}} - 1.5 \text{ LSB}$ ), after adjusting for offset error.

**INTEGRAL NON-LINEARITY (INL)** is a measure of the deviation of each individual code from a line drawn from negative full scale ( $\frac{1}{2}$  LSB below the first code transition) through positive full scale ( $\frac{1}{2}$  LSB above the last code transition). The deviation of any given code from this straight line is measured from the center of that code value.

**INTERMODULATION DISTORTION (IMD)** is the creation of additional spectral components as a result of two sinusoidal frequencies being applied to the ADC input at the same time. It is defined as the ratio of the power in the second and third

order intermodulation products to the sum of the power in both of the original frequencies. IMD is usually expressed in dB.

**MISSING CODES** are those output codes that will never appear at the ADC outputs. The ADC124S051 is guaranteed not to have any missing codes.

**OFFSET ERROR** is the deviation of the first code transition (000...000) to (000...001) from the ideal (i.e.  $\text{GND} + 0.5 \text{ LSB}$ ).

**SIGNAL TO NOISE RATIO (SNR)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or d.c.

**SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding d.c.

**SPURIOUS FREE DYNAMIC RANGE (SFDR)** is the difference, expressed in dB, between the rms values of the input signal and the peak spurious signal where a spurious signal is any signal present in the output spectrum that is not present at the input, excluding d.c.

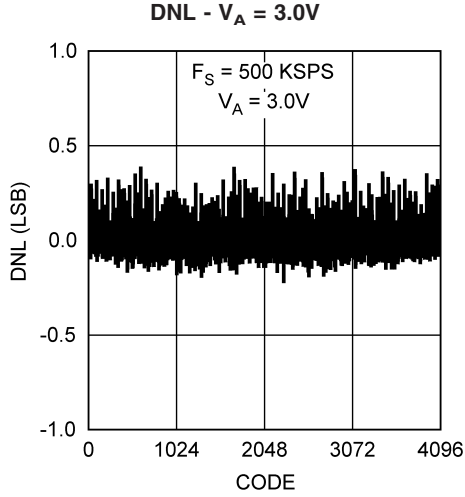
**TOTAL HARMONIC DISTORTION (THD)** is the ratio, expressed in dB or dBc, of the rms total of the first five harmonic components at the output to the rms level of the input signal frequency as seen at the output. THD is calculated as

$$\text{THD} = 20 \cdot \log_{10} \sqrt{\frac{A_{f_2}^2 + \dots + A_{f_6}^2}{A_{f_1}^2}}$$

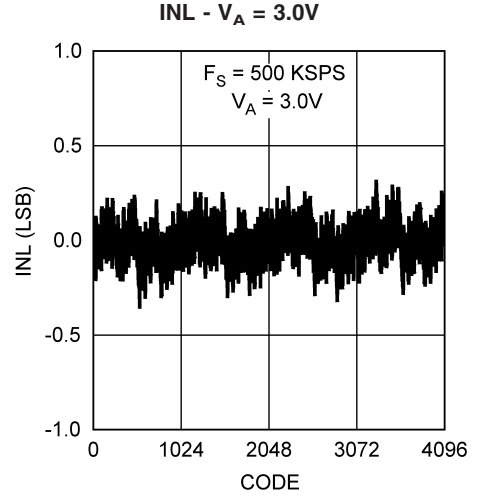
where  $A_{f_1}$  is the RMS power of the input frequency at the output and  $A_{f_2}$  through  $A_{f_6}$  are the RMS power in the first 5 harmonic frequencies.

**THROUGHPUT TIME** is the minimum time required between the start of two successive conversion. It is the acquisition time plus the conversion time. In the case of the ADC124S051, this is 16 SCLK periods.

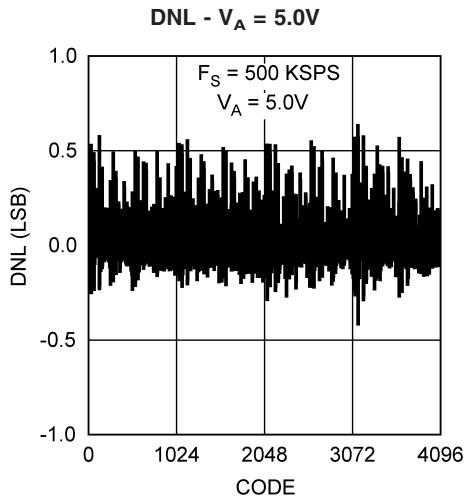
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kSPS to } 500 \text{ kSPS}$ ,  $f_{\text{SCLK}} = 3.2 \text{ to } 8 \text{ MHz}$ ,  $f_{\text{IN}} = 40.2 \text{ kHz}$  unless otherwise stated.



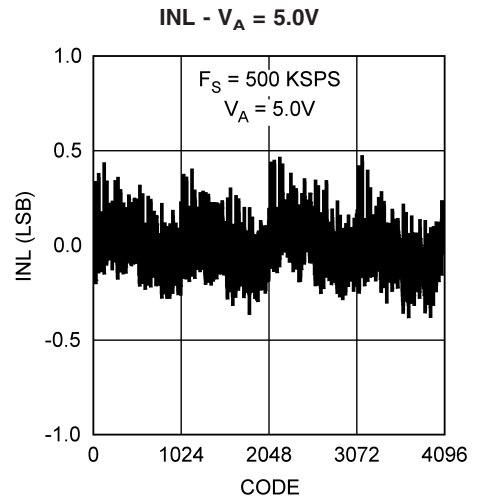
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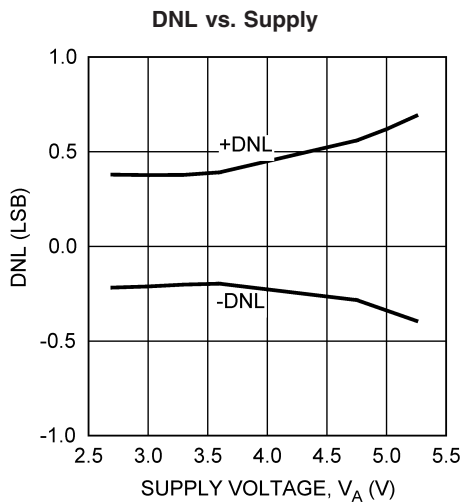
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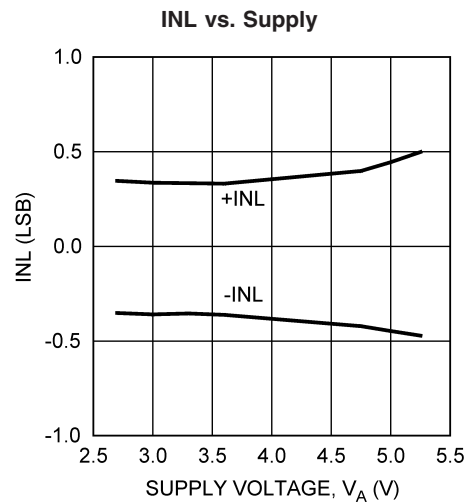
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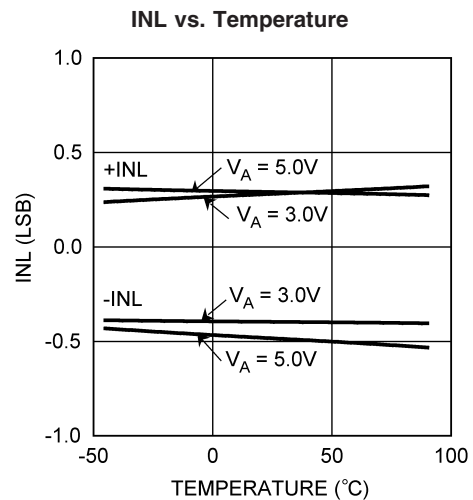
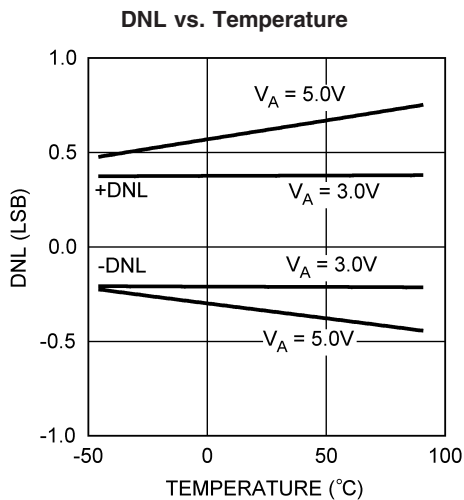
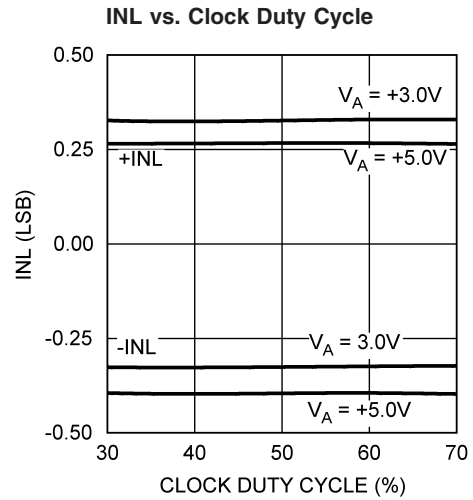
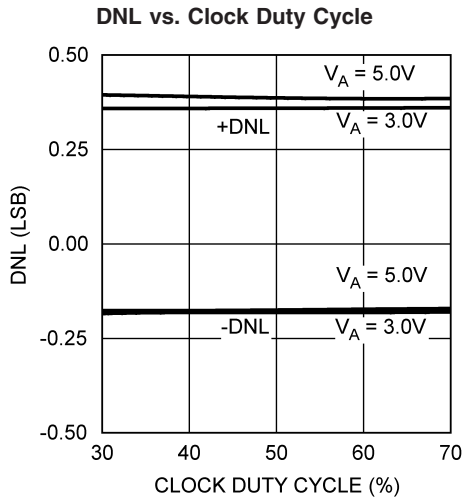
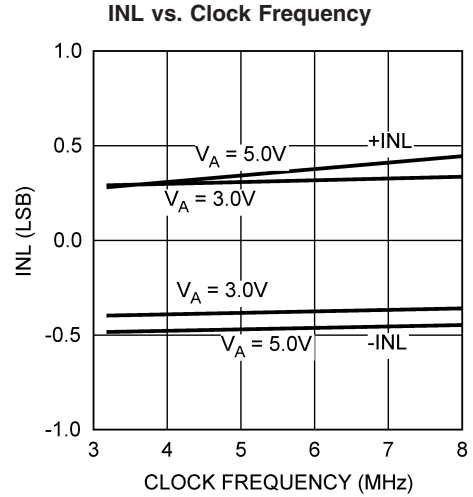
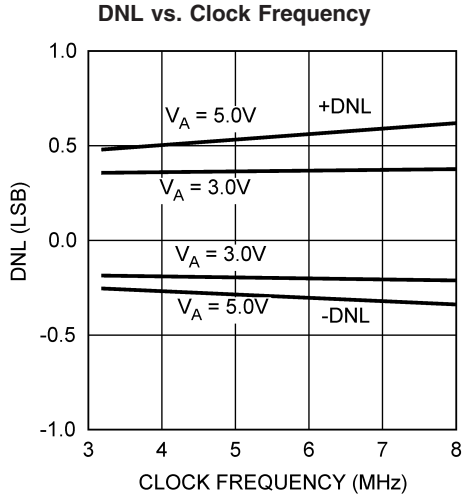
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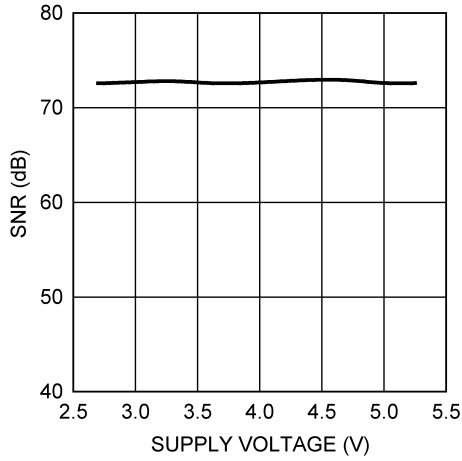


**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kSPS to } 500 \text{ kSPS}$ ,  $f_{\text{SCLK}} = 3.2 \text{ to } 8 \text{ MHz}$ ,  $f_{\text{IN}} = 40.2 \text{ kHz}$  unless otherwise stated. (Continued)



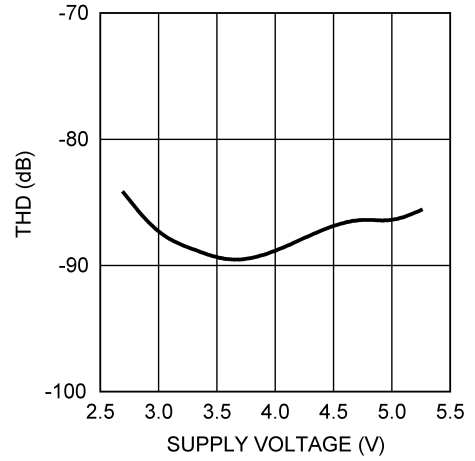
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kSPS to } 500 \text{ kSPS}$ ,  $f_{\text{SCLK}} = 3.2 \text{ to } 8 \text{ MHz}$ ,  $f_{\text{IN}} = 40.2 \text{ kHz}$  unless otherwise stated. (Continued)

**SNR vs. Supply**



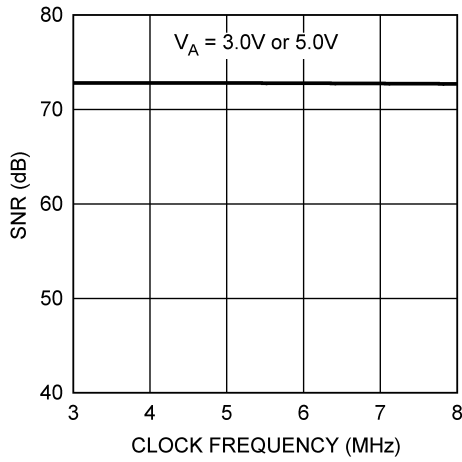
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**THD vs. Supply**



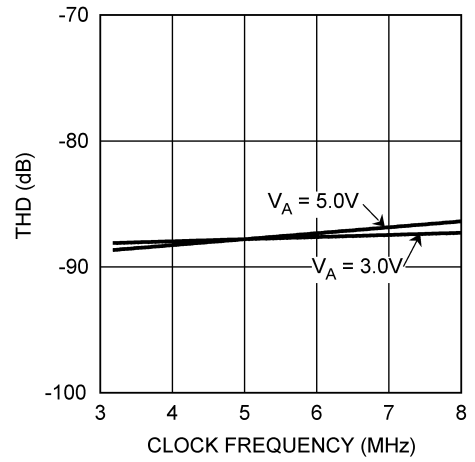
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**SNR vs. Clock Frequency**



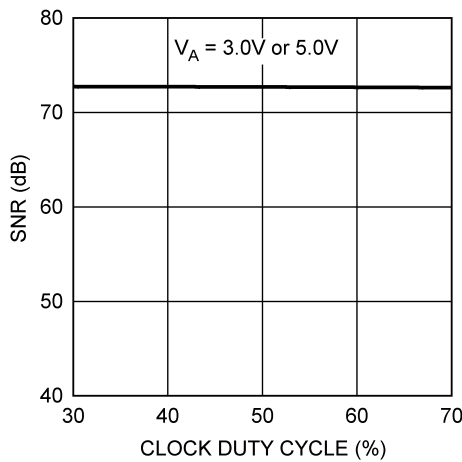
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**THD vs. Clock Frequency**



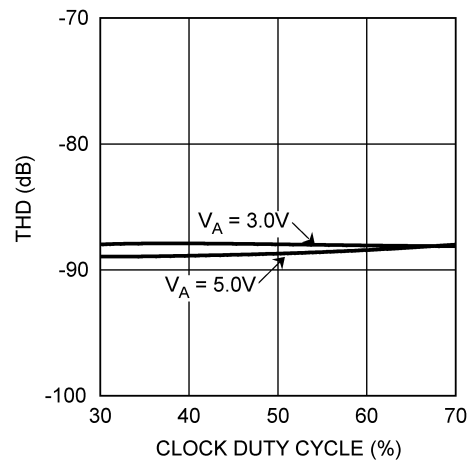
20111336

**SNR vs. Clock Duty Cycle**



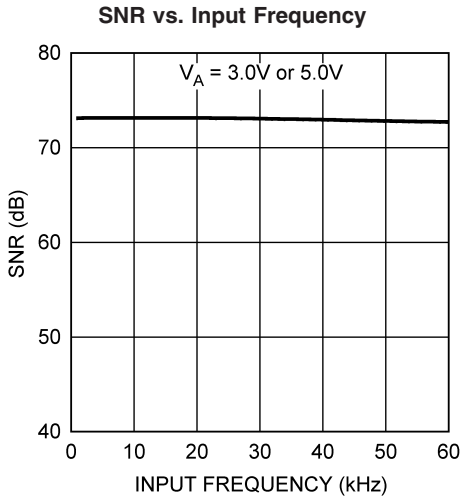
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**THD vs. Clock Duty Cycle**

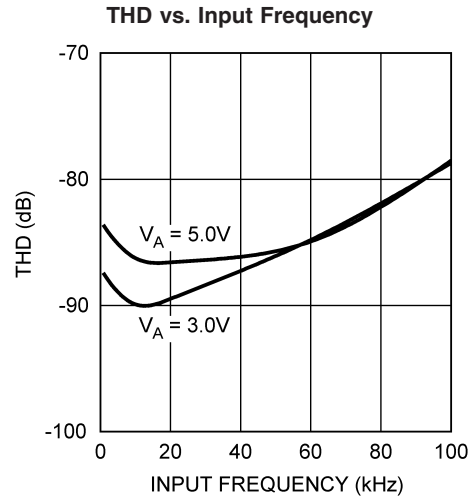


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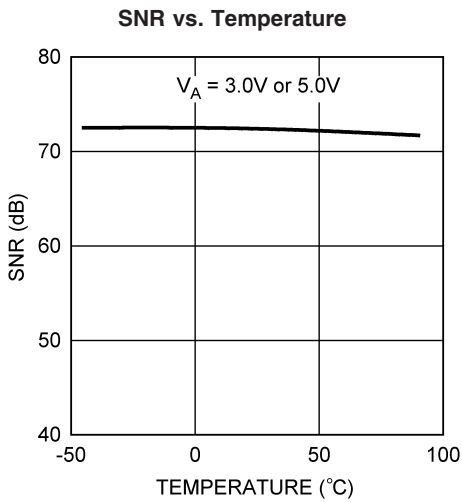
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kSPS to } 500 \text{ kSPS}$ ,  $f_{\text{SCLK}} = 3.2 \text{ to } 8 \text{ MHz}$ ,  $f_{\text{IN}} = 40.2 \text{ kHz}$  unless otherwise stated. (Continued)



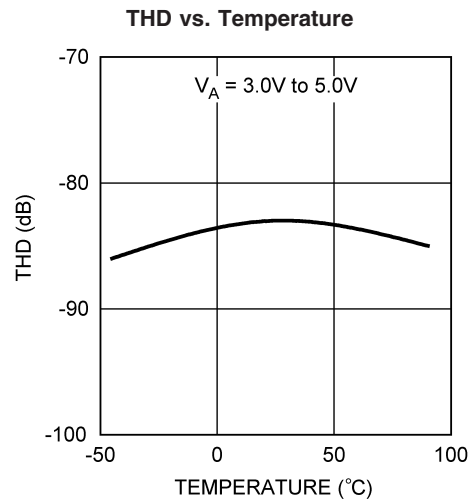
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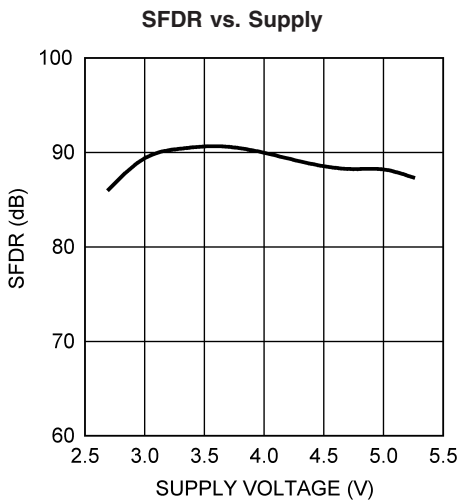
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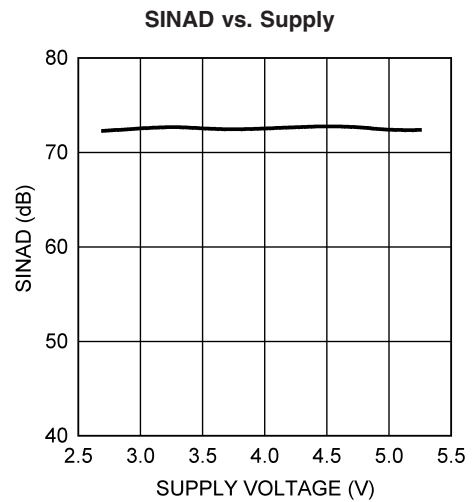
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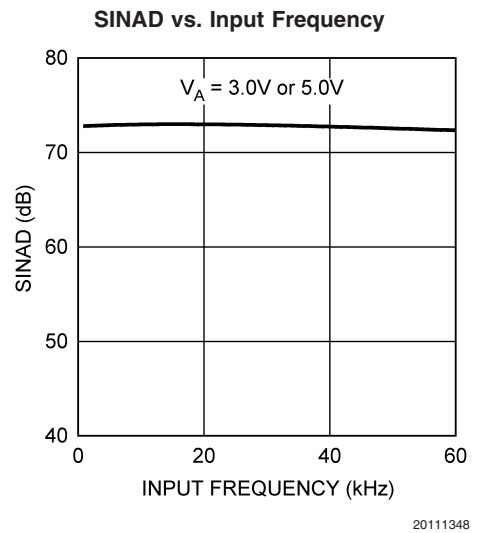
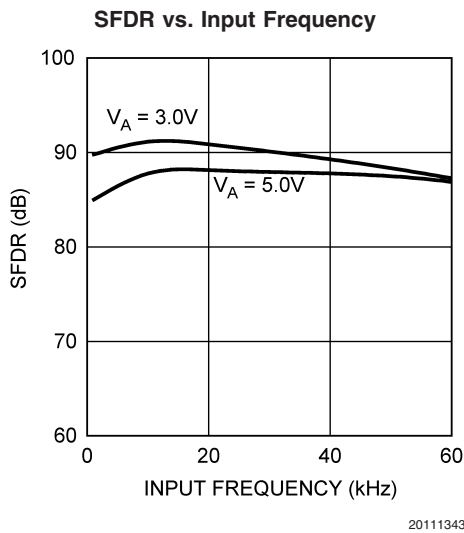
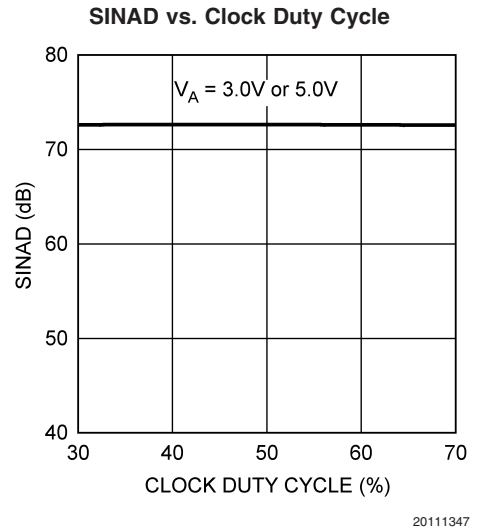
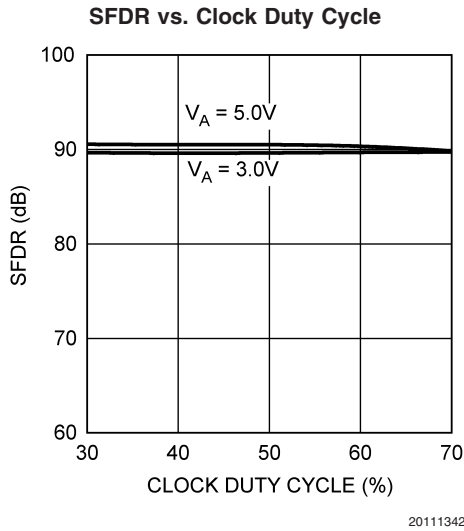
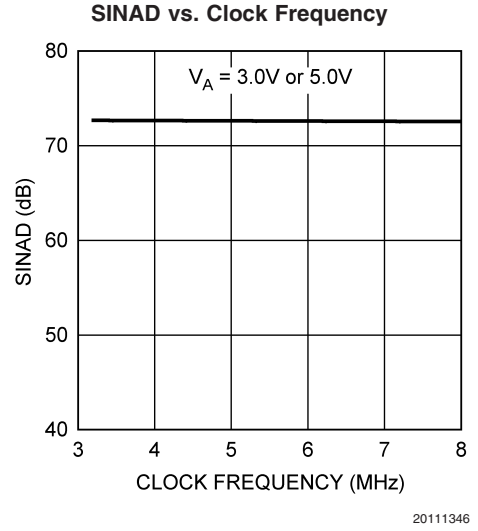
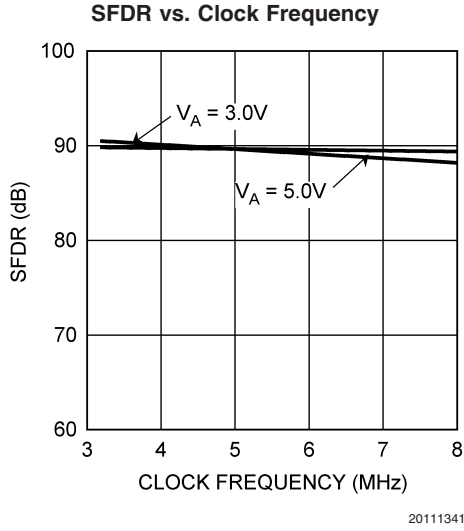


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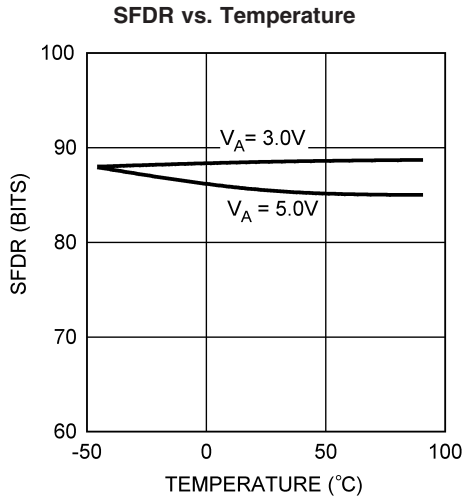


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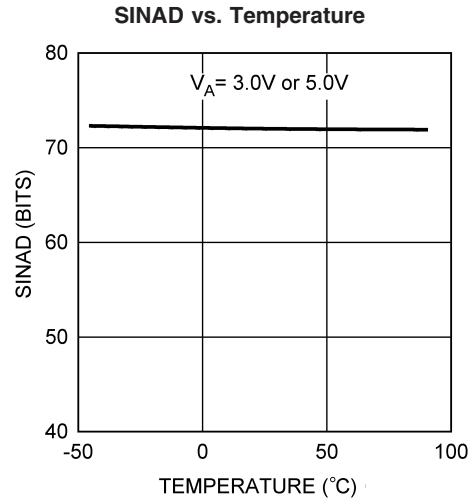
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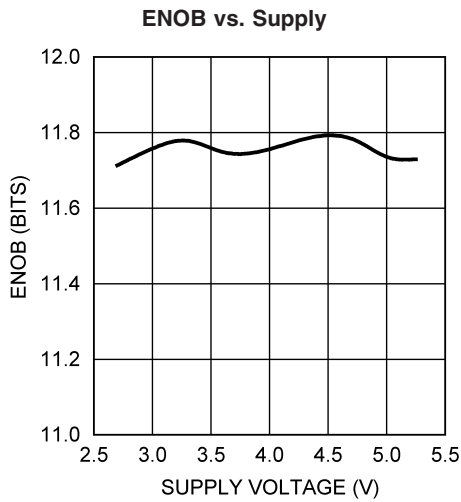
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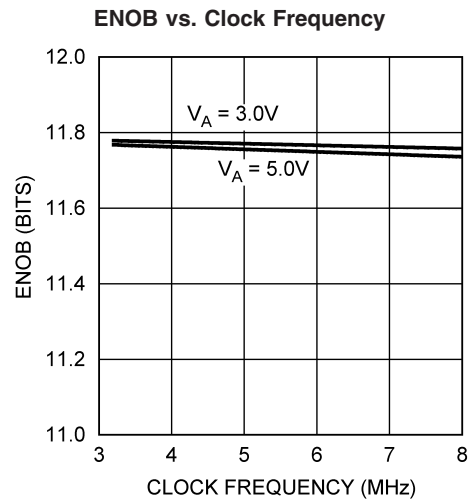
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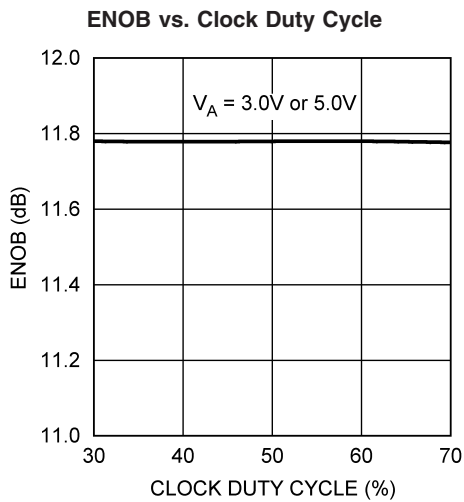
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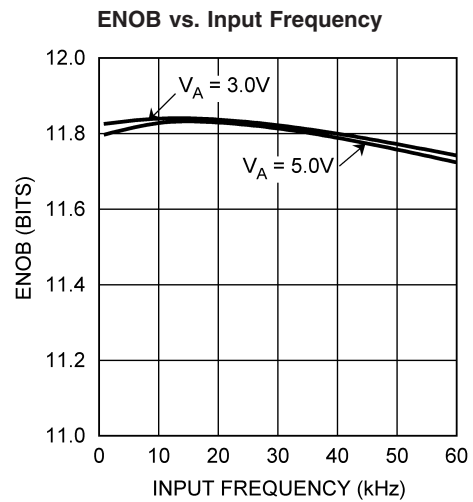
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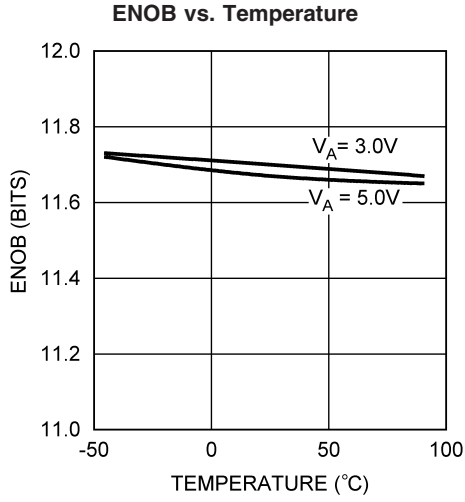


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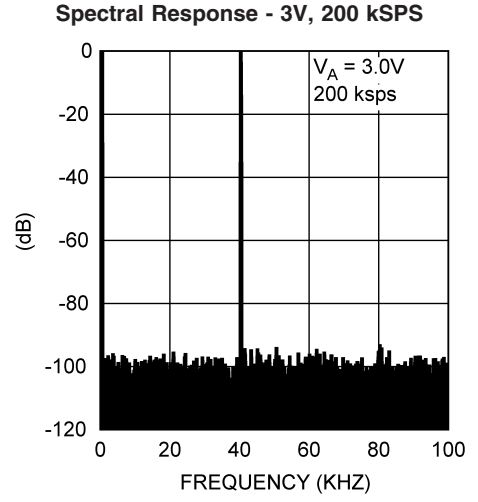


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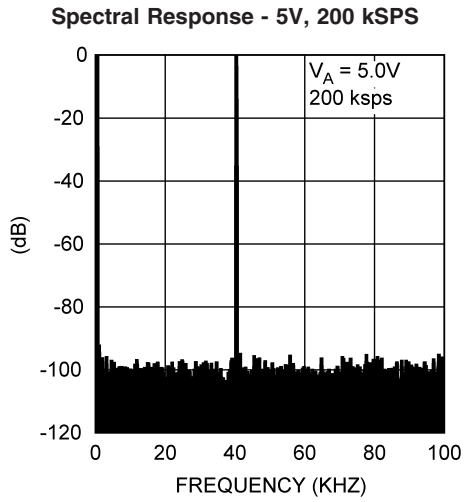
**Typical Performance Characteristics**  $T_A = +25^\circ\text{C}$ ,  $f_{\text{SAMPLE}} = 200 \text{ kSPS}$  to  $500 \text{ kSPS}$ ,  $f_{\text{SCLK}} = 3.2$  to  $8 \text{ MHz}$ ,  $f_{\text{IN}} = 40.2 \text{ kHz}$  unless otherwise stated. (Continued)



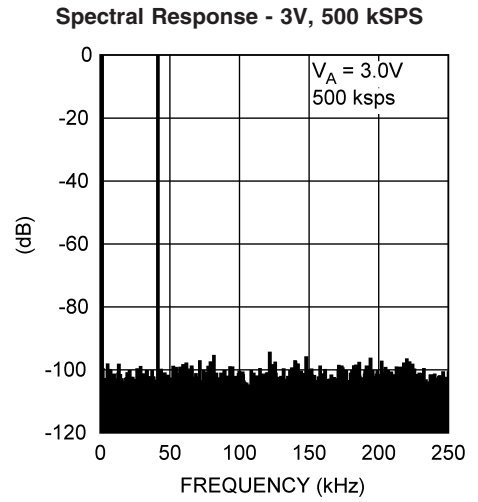
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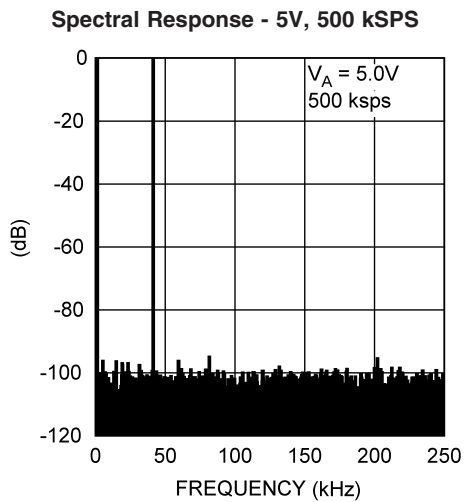
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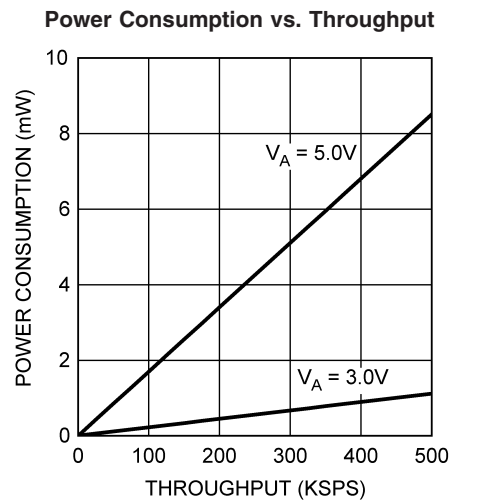
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## Applications Information

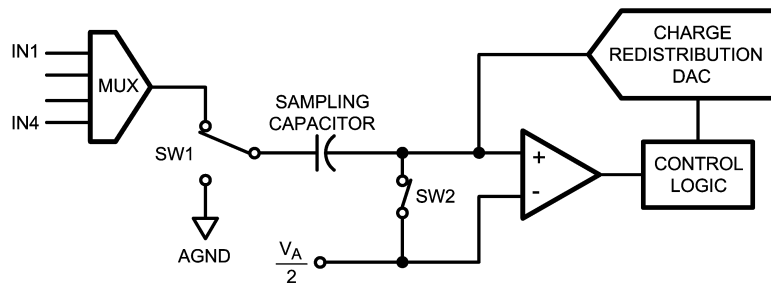
### 1.0 ADC124S051 OPERATION

The ADC124S051 is a successive-approximation analog-to-digital converter designed around a charge-redistribution digital-to-analog converter. Simplified schematics of the ADC124S051 in both track and hold modes are shown in *Figures 1, 2*, respectively. In *Figure 1*, the ADC124S051 is in track mode: switch SW1 connects the sampling capacitor to one of four analog input channels through the multiplexer, and SW2 balances the comparator inputs. The ADC124S051 is in this state for the first three SCLK cycles after  $\overline{CS}$  is brought low.

*Figure 2* shows the ADC124S051 in hold mode: switch SW1 connects the sampling capacitor to ground, maintaining the

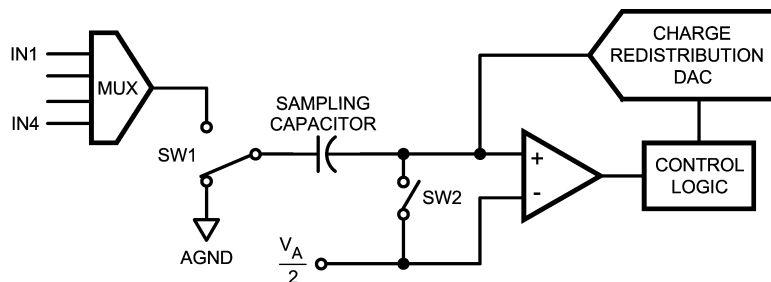
sampled voltage, and switch SW2 unbalances the comparator. The control logic then instructs the charge-redistribution DAC to add fixed amounts of charge to the sampling capacitor until the comparator is balanced. When the comparator is balanced, the digital word supplied to the DAC is the digital representation of the analog input voltage. The ADC124S051 is in this state for the fourth through sixteenth SCLK cycles after  $\overline{CS}$  is brought low.

The time when  $\overline{CS}$  is low is considered a serial frame. Each of these frames should contain an integer multiple of 16 SCLK cycles, during which time a conversion is performed and clocked out at the DOUT pin and data is clocked into the DIN pin to indicate the multiplexer address for the next conversion.



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FIGURE 1. ADC124S051 in Track Mode



20111310

FIGURE 2. ADC124S051 in Hold Mode

### 2.0 USING THE ADC124S051

An ADC124S051 timing diagram and a serial interface timing diagram for the ADC124S051 are shown in the Timing Diagrams section.  $\overline{CS}$  is chip select, which initiates conversions and frames the serial data transfers. SCLK (serial clock) controls both the conversion process and the timing of serial data. DOUT is the serial data output pin, where a conversion result is sent as a serial data stream, MSB first. Data to be written to the ADC124S051's Control Register is placed on DIN, the serial data input pin. New data is written to DIN with each conversion.

A serial frame is initiated on the falling edge of  $\overline{CS}$  and ends on the rising edge of  $\overline{CS}$ . Each frame must contain an integer multiple of 16 rising SCLK edges. The ADC output data (DOUT) is in a high impedance state when  $\overline{CS}$  is high and is active when  $\overline{CS}$  is low. Thus,  $\overline{CS}$  acts as an output enable. Additionally, the device goes into a power down state when  $\overline{CS}$  is high, and also between continuous conversion cycles.

During the first 3 cycles of SCLK, the ADC is in the track mode, acquiring the input voltage. For the next 13 SCLK cycles the conversion is accomplished and the data is clocked out, MSB first, starting on the 5th clock. If there is more than one conversion in a frame, the ADC will re-enter the track mode on the falling edge of SCLK after the  $N \cdot 16$ th rising edge of SCLK, and re-enter the hold/convert mode on the  $N \cdot 16 + 4$ th falling edge of SCLK, where "N" is an integer.

When  $\overline{CS}$  is brought high, SCLK is internally gated off. If SCLK is stopped in the low state while  $\overline{CS}$  is high, the subsequent fall of  $\overline{CS}$  will generate a falling edge of the internal version of SCLK, putting the ADC into the track mode. This is seen by the ADC as the first falling edge of SCLK. If SCLK is stopped with SCLK high, the ADC enters the track mode on the first falling edge of SCLK after the falling edge of  $\overline{CS}$ .

During each conversion, data is clocked into the DIN pin on the first 8 rising edges of SCLK after the fall of  $\overline{CS}$ . For each

## Applications Information (Continued)

conversion, it is necessary to clock in the data indicating the input that is selected for the conversion after the current one. See *Tables 1, 2* and *Table 3*.

If  $\overline{CS}$  and SCLK go low simultaneously, it is the following rising edge of SCLK that is considered the first rising edge for clocking data into DIN.

There are no power-up delays or dummy conversions required with the ADC124S051. The ADC is able to sample and convert an input to full conversion immediately following power up. The first conversion result after power-up will be that of IN1.

**TABLE 1. Control Register Bits**

Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
DONTC	DONTC	ADD2	ADD1	ADD0	DONTC	DONTC	DONTC

**TABLE 2. Control Register Bit Descriptions**

Bit #:	Symbol:	Description
7 - 6, 2 - 0	DONTC	Don't care. The value of these bits do not affect device operation.
5	ADD2	These three bits determine which input channel will be sampled and converted in the next track/hold cycle. The mapping between codes and channels is shown in <i>Table 3</i> .
4	ADD1	
3	ADD0	

**TABLE 3. Input Channel Selection**

ADD2	ADD1	ADD0	Input Channel
x	0	0	IN1 (Default)
x	0	1	IN2
x	1	0	IN3
x	1	1	IN4



## Applications Information (Continued)

### 3.0 ADC124S051 TRANSFER FUNCTION

The output format of the ADC124S051 is straight binary. Code transitions occur midway between successive integer

LSB values. The LSB width for the ADC124S051 is  $V_A/4096$ . The ideal transfer characteristic is shown in *Figure 3*. The transition from an output code of 0000 0000 0000 to a code of 0000 0000 0001 is at  $1/2$  LSB, or a voltage of  $V_A/8192$ . Other code transitions occur at steps of one LSB.

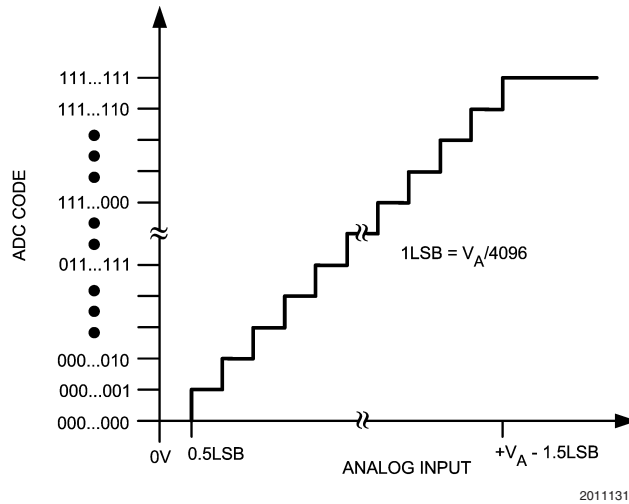


FIGURE 3. Ideal Transfer Characteristic

### 4.0 TYPICAL APPLICATION CIRCUIT

A typical application of the ADC124S051 is shown in *Figure 4*. Power is provided in this example by the National Semiconductor LP2950 low-dropout voltage regulator, available in a variety of fixed and adjustable output voltages. The power supply pin is bypassed with a capacitor network located close to the ADC124S051. Because the reference for the ADC124S051 is the supply voltage, any noise on the supply

will degrade device noise performance. To keep noise off the supply, use a dedicated linear regulator for this device, or provide sufficient decoupling from other circuitry to keep noise off the ADC124S051 supply pin. Because of the ADC124S051's low power requirements, it is also possible to use a precision reference as a power supply to maximize performance. The four-wire interface is also shown connected to a microprocessor or DSP.

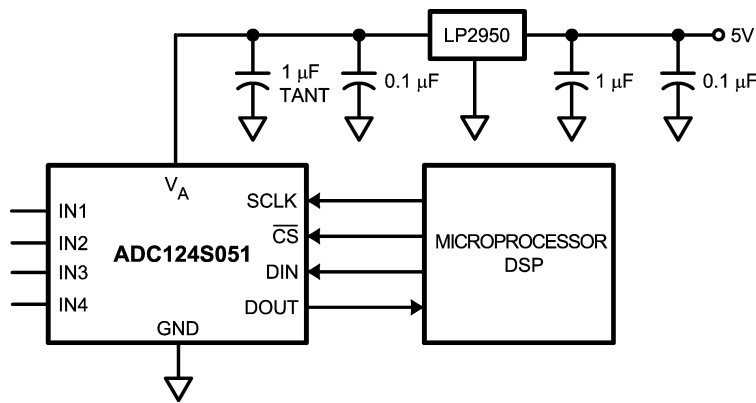


FIGURE 4. Typical Application Circuit

## Applications Information (Continued)

### 5.0 ANALOG INPUTS

An equivalent circuit for one of the ADC124S051's input channels is shown in *Figure 5*. Diodes D1 and D2 provide ESD protection for the analog inputs. At no time should any input go beyond ( $V_A + 300$  mV) or ( $GND - 300$  mV), as these ESD diodes will begin conducting, which could result in erratic operation.

The capacitor C1 in *Figure 5* has a typical value of 3 pF, and is mainly the package pin capacitance. Resistor R1 is the on resistance of the multiplexer and track / hold switch, and is typically 500 ohms. Capacitor C2 is the ADC124S051 sampling capacitor, and is typically 30 pF. The ADC124S051 will deliver best performance when driven by a low-impedance source to eliminate distortion caused by the charging of the sampling capacitance. This is especially important when using the ADC124S051 to sample AC signals. Also important when sampling dynamic signals is a band-pass or low-pass filter to reduce harmonics and noise, improving dynamic performance.

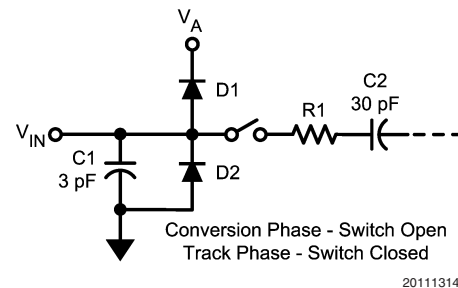


FIGURE 5. Equivalent Input Circuit

### 6.0 DIGITAL INPUTS AND OUTPUTS

The ADC124S051's digital output DOUT is limited by, and cannot exceed, the supply voltage,  $V_A$ . The digital input pins are not prone to latch-up and, although not recommended, SCLK, CS and DIN may be asserted before  $V_A$  without any latchup risk.

### 7.0 POWER SUPPLY CONSIDERATIONS

The ADC124S051 is fully powered-up whenever  $\overline{CS}$  is low, and fully powered-down whenever  $\overline{CS}$  is high, with one exception: the ADC124S051 automatically enters power-down mode between the 16th falling edge of a conversion and the 1st falling edge of the subsequent conversion (see Timing Diagrams).

The ADC124S051 can perform multiple conversions back to back; each conversion requires 16 SCLK cycles. The ADC124S051 will perform conversions continuously as long as  $\overline{CS}$  is held low.

The user may trade off throughput for power consumption by simply performing fewer conversions per unit time. The Power Consumption vs. Sample Rate curve in the Typical Performance Curves section shows the typical power consumption of the ADC124S051 versus throughput. To calculate the power consumption, simply multiply the fraction of time spent in the normal mode by the normal mode power consumption, and add the fraction of time spent in shutdown mode multiplied by the shutdown mode power dissipation.

### 7.1 Power Management

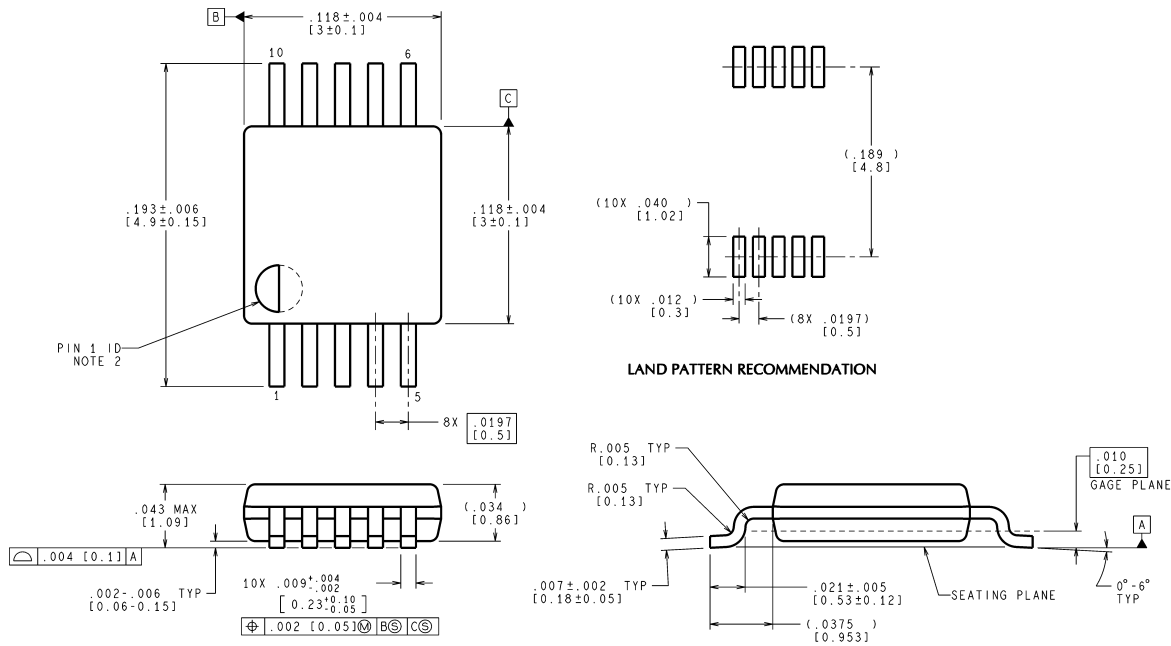
When the ADC124S051 is operated continuously in normal mode, the maximum throughput is  $f_{SCLK}/16$ . Throughput may be traded for power consumption by running  $f_{SCLK}$  at its maximum 8 MHz and performing fewer conversions per unit time, putting the ADC124S051 into shutdown mode between conversions. A plot of typical power consumption versus throughput is shown in the Typical Performance Curves section. To calculate the power consumption for a given throughput, multiply the fraction of time spent in the normal mode by the normal mode power consumption and add the fraction of time spent in shutdown mode multiplied by the shutdown mode power consumption. Generally, the user will put the part into normal mode and then put the part back into shutdown mode. Note that the curve of power consumption vs. throughput is nearly linear. This is because the power consumption in the shutdown mode is so small that it can be ignored for all practical purposes.

### 7.2 Power Supply Noise Considerations

The charging of any output load capacitance requires current from the power supply,  $V_A$ . The current pulses required from the supply to charge the output capacitance will cause voltage variations on the supply. If these variations are large enough, they could degrade SNR and SINAD performance of the ADC. Furthermore, discharging the output capacitance when the digital output goes from a logic high to a logic low will dump current into the die substrate, which is resistive. Load discharge currents will cause "ground bounce" noise in the substrate that will degrade noise performance if that current is large enough. The larger is the output capacitance, the more current flows through the die substrate and the greater is the noise coupled into the analog channel, degrading noise performance.

To keep noise out of the power supply, keep the output load capacitance as small as practical. If the load capacitance is greater than 35 pF, use a 100  $\Omega$  series resistor at the ADC output, located as close to the ADC output pin as practical. This will limit the charge and discharge current of the output capacitance and improve noise performance.

**Physical Dimensions** inches (millimeters) unless otherwise noted



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MUB10A (Rev B)

**10-Lead MSOP**  
**Order Number ADC124S051CIMM, ADC124S051CIMMX**  
**NS Package Number P0MUB10A**

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